

**Table of Contents**

2	Notes
3	Block Diagram
4	MPC5744 MCU in SKT
5	MPC5744 MCU
6	Power, RST, LIN, CAN
7	JTAG & NEXUS
8	MB Connections 1
9	MB Connections 2

**Revisions**

Rev	Description	Date	Approved
A	Prototype Release	21 May 12	J.H.
A1	Update from DVT - Change shunt on J6 to pins 2-3 - Change shunt on J24 to pins 2-4 - Change shunts on J17 to wirejumpers from 8-12,9-11,2-6,3-5 - Change R224, R225, R226, R227, R230 and R231 to zero ohms.	02 Jul 12	J.H.
AX1	Update from DVT - Remove R224 thru R227,R230 & R231 and connect pin 2 of C211,C213, C216,C221,C234, and C235 to GND. - Change connection to J18 pin3 to MB_PTC6 and J18 pin 6 to MB_PTC7. - Change connection to J17 pin 2 to be PTB1,pin 5 to be PTB0,pin 8 to be PBB3,and pin 11 to be PTB2. - Update default shunt positions to match. - Update MCU to the new library parts.	07 Nov 12	J.H.
AX2	- Crystal & OSC Circuits, Series resistor options were replaced by Jumpers. (210-30004)	20 Mar 13	Barbara
AX3	- Q1 MFR-PN changed to PDTC115TE. - Y200 Preferred MFR-PN changed to CX3225GA4000D0PTVZ1 - SW3 MFR-PN changed to 1101M2S3CQE2 - R235 changed to two pin jumper JP6.	22 Mar 13 25 Mar 13 27 Mar 13	Marilyn & Barbara
B	A085 Release	05 Apr 13	Marilyn & Barbara
EX1	1. R16 - 249K changed to 24.9K(470-30990) 2. R18 - 80.6K changed to 8.06K(470-30936) 3. R17 - 2.15K changed to 510(470-80725) 4. R19 - 82.5K changed to 18K(470-30974) 5. C15 - 56PF changed to 680PF(150-79131) 6. C16 - 100PF changed to 150PF(150-77532) 7. R20 - 200K changed to 11K(470-30951) 8. Added 1x2 HDR (J25) and 10K pullup resistor(R249) on the SBC_FSI to V_PRE. 9. Added pull down resistor R250-100K (470-75597) on SBC_IO2. 10. SBC_IO3 net pulled up to SB_VCORE through R251 -10K(470-75416). 11. C14 -22UF changed to 4.7UF(150-30266) 12. C248 -22UF changed to 4.7UF(150-30266) 13. C7 -4.7UF changed to 1.0UF(150-77475) 14. Added pull down resistors 100K (R252, R253 and R254) on the nets SBC_IO1, SBC_IO4 and SBC_IO5 respectively. 15. C17 -10uF changed to 22uF(150-77933) 16. J24 HDR2x3 repalced by R256 & R257 4.99K(470-30913) & also marked as DNP.	17 Sep 14	Fraser Jamaal
EX2	1. D19-(9480-75144), J27-2x2H(211-75268) Q3-(480-78185) added on V_PRE circuitry. 2. SW4(510-75093), R259-4.99K(470-30913) C255 -0.1uF(150-75142),R262-510K (470-76166) added near to J10 Connector. 3. R260-24.9K(470-30990)&R261-8.06K (470-30936)connected to FB_CORE, 4. IO_1 FB_CORE connected to J10-3rd Pin	18 Sep 14	Fraser Jamaal
EX3	1. J26-2x2H(211-75268) added across R252 to SBC_IO1. 2. R260-24.9K(470-30990) are connected to SB_VCORE,instead of FB_VCORE. 3. Pin 3 of Q3(480-78185)connected to GND. 4. Pin 3 of Q3(480-78185)connected to GND. 5. Pin 2 of J24 connected to Pin 1 of Q3. A070 Release	26 Sep 14	Fraser Jamaal
EX4	1. Changed default assigned net names to user defined net names(VPRE_D and GATE_LS)	30 Sep 14	Fraser Jamaal
C	1. Removed the pull up resistors on the Power SBC's select pin (U3.31) and replaced two pull down resistors (49.9K    4.9K) by a single pull down resitor (5.1K ohm). A085 Release	08 Oct 14	Fraser Jamaal
C1	U3, replaced 315-79478 with 315-80391	03 Mar 15	DK
D	Revision-C A085 Release 1.U3 is changed to 315-80572 (FSG5221AE); 2.Y201 is change to 230-75398 (ECS-3953C-080B) 3.L2 is change to 180-78432 (ACT1210-510-2P-TL00) 4.R19 is change to 470-81693	31 Jul 18	Dennis Zeng
D1	add jumper setting table (see page 3)	24 Oct 18	J. Q.

		<b>Automotive Product Group</b> 6501 William Cannon Drive West Austin, TX 78755-8508	
This document contains information proprietary to NXP and shall not be used for engineering design, procurement or manufacture in whole or in part without the express written permission of NXP Semiconductors.			
ICAP Classification: CP		IUC: X PUBI:	
Designer: Jay Hartvigsen	Drawing Title: <b>MPC5744P-144DS</b>		
Drawn by: Jay Hartvigsen	Page Title: <b>Title Page</b>		
Approved: Barbara	Size C	Document Number SCH-27513; SPF-27513	Rev D1
Date: Wednesday, October 24, 2018		Sheet 1 of 9	

1. Interrupted lines coded with the same letter or letter combinations are electrically connected.
2. Device type number is for reference only. The number varies with the manufacturer.
3. Special signal usage:  
 \_B Denotes - Active-Low Signal  
 <> or [] Denotes - Vectored Signals
4. Interpret diagram in accordance with American National Standards Institute specifications, current revision, with the exception of logic block symbology.

## Power & Ground Nets

### MOTHER BOARD SUPPLIED POWER

1.25V_MB_SR	1.25V	
3.3V_MB_SR	3.3V	
5V_MB_SR	5V	From the MB switching regulator - only used to provide power back to the MB I/O circuits
5V_MB_LR	5V	From the MB linear regulator - used for 3.3V on the daughter card

### EXTERNALLY SUPPLIED POWER

EXT_PWR	12V	External power supplied through the barrel connector to the System Basis Chip (SBC) - MC33907
EXT_PWR_SW	12V	EXT_PWR out of the power switch - used by the SBC to detect input power
VSUP	12V	EXT_PWR_SW after the reverse voltage protection diode
1.25V_DC_LR	1.25V	External power into pin 1 of the terminal block
3.3V_DC_LR	3.3V	External power into pin 2 of the terminal block
5V_DC_LR	5V	External power into pin 3 of the terminal block

### SYSTEM BASIS CHIP (SBC) POWER NETS

VSUP12	12V	Power into the pre-regulator switching regulator in the SBC
V_PRE	6.5V	Power out of the pre-regulator switching regulator in the SBC
SB_VCORE	3.3V	Power out of the core switching regulator in the SBC
SB_VAUX	3.3V	Power out of the VAUX linear regulator in the SBC
SB_VCCA	3.3V	Power out of the VCCA linear regulator in the SBC
VCAN	5V	Power out of the CAN linear regulator in the SBC

### POWER TO THE MCU

VDD_LV_CORE	1.25V	Power to the core logic on the MCU
VDD_LV_EXT	1.25V	Power derived from VDD_HV_PMU and regulated by the MCU through an external transistor
VDD_LV_PLL	1.25V	Power to the pll circuit on the MCU
VDD_HV_PMU	3.3V	Power to the pmu circuit on the MCU
VDD_HV_IO	3.3V	Power to the I/O circuits on the MCU
VDD_HV_OSC0	3.3V	Power to the oscillator circuit on the MCU
VDD_HV_FLA0	3.3V	Power to the flash memory circuit on the MCU
VDD_HV_ADV0/1	3.3V	Power to the ADC circuit on the MCU
VDD_HV_ADR0	3.3V	Reference voltage to the ADC0 circuit on the MCU
VDD_HV_ADR1	3.3V	Reference voltage to the ADC1 circuit on the MCU

### GROUND NETS

GND	0V	
VSS_PLL	0V	Filtered ground for the on chip PLL circuit
VSS_OSC	0V	Filtered ground for the on chip oscillator circuit
VSSA	0V	Filtered ground for the on chip ADC circuits



<b>Notes</b>			
Size	Document Number	Rev	
C	SCH-27513: SPF-27513	D1	
Date:	Wednesday, October 24, 2018	Sheet	2 of 8

REF DES	JUMPER(DEFAULT)	PAGE NAME
J12	1-2	04 MPC5744 MCU in SKT
J6	2-3	04 MPC5744 MCU in SKT
J1,J16,J19,J23,J3,J20,J21,J22	3-4	04 MPC5744 MCU in SKT
J7	1-2, 3-4, 5-6	05 MPC5744 MCU
J27	1-2, 3-4	06 Power, RST, LIN, CAN
J25,J15	1-2	06 Power, RST, LIN, CAN
J9	1-3, 2-4	06 Power, RST, LIN, CAN
J18,J17	2-3, 5-6, 8-9, 11-12	06 Power, RST, LIN, CAN
J10	3-4	06 Power, RST, LIN, CAN
J2,J26	NONE	06 Power, RST, LIN, CAN
J13	2-3	08 MB Connections 1

REF DES	ASSY_OPT	PAGE NAME
R229,R221,JP6,JP1,JP5,JP2, R232,C243	DNP	04 MPC5744 MCU in SKT
U2,TP26	DNP	05 MPC5744 MCU
D12,R15	DNP	06 Power, RST, LIN, CAN

REF DES	SWITCH(DEFAULT)	PAGE NAME
SW4	A	06 Power, RST, LIN, CAN
SW3	OFF	06 Power, RST, LIN, CAN

Sheet 4

MPC5744P MCU in Socket

40 MHz XTAL

8 MHz Crystal Oscillator

SMA for External Clock

Power Selector for VDD\_LV\_CORE

Power Selector for VDD\_LV\_PLL

Power Selector for VDD\_HV\_PMU

Power Selector for VDD\_HV\_IO

Power Selector for VDD\_HV\_OSC0

Power Selector for VDD\_HV\_FLA0

Power Selector for VDD\_HV\_ADV0/1

Power Selector for VDD\_HV\_ADR0

Power Selector for VDD\_HV\_ADR1

VSS\_PLL, VSS\_OSC, VSSA filters

Sheet 6

External Power Jack

External Power Switch & LED

External Power Terminal Block

Terminal Block Power LEDs

SBC Power Supply

Vcca/Vaux Voltage Sel Header

SBC I/O & MCU FCCU\_F0,1 Header

SBC Power LEDs (V\_PRE, VCCA,  
VAUX, VCAN, VCORE)

SBC FS0 and FS1 LEDs

CAN Interface

LIN Interface

RESET & POR Push Buttons & LEDs

SPI, CAN, & LIN Source Headers

Sheet 5

MPC5744P MCU

MC\_RGM Boot Selector

Sheet 7

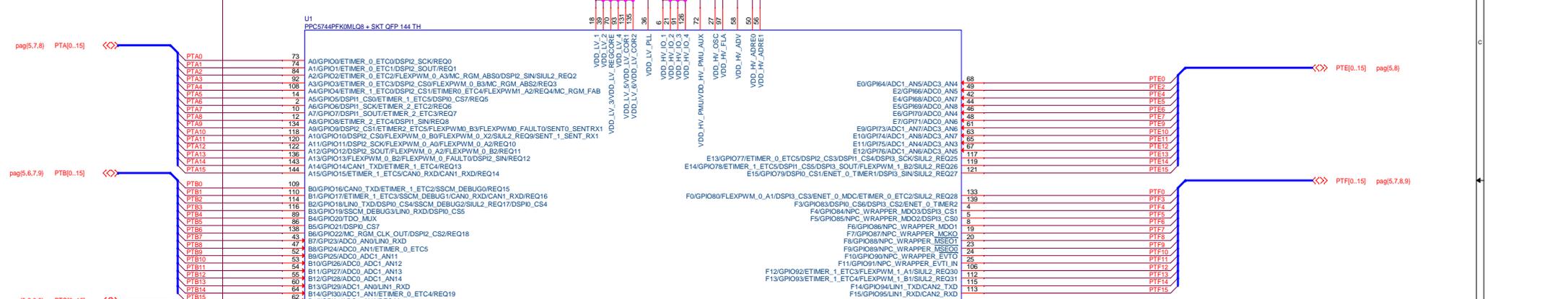
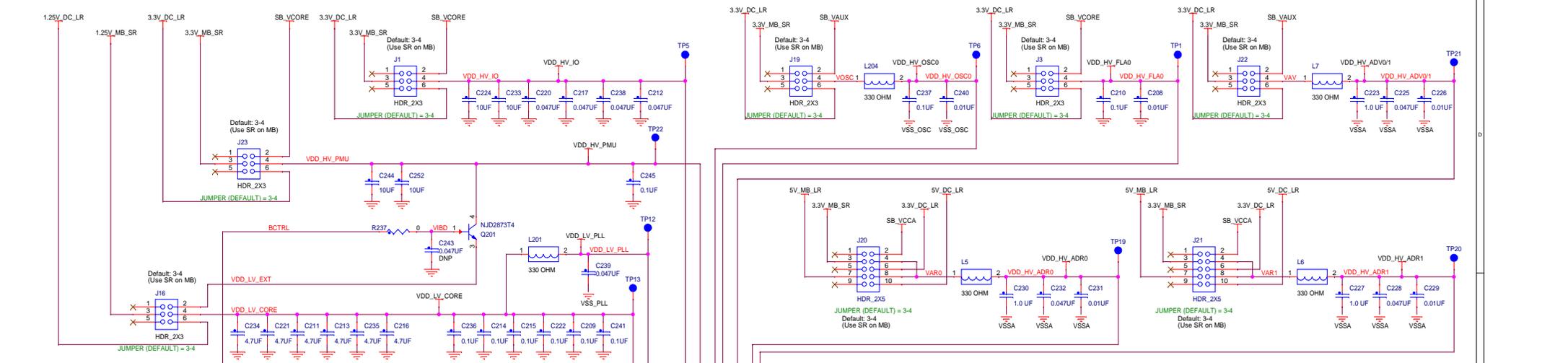
Nexus Connector

JTAG Connector

Sheets 8 and 9

Motherboard Connectors





**Note: To test with the Leopard chip remove the zero ohm resistors to the port J bus and EXT\_POR\_B and move them to the DNP locations to connect to VDD\_HV\_PMU.**

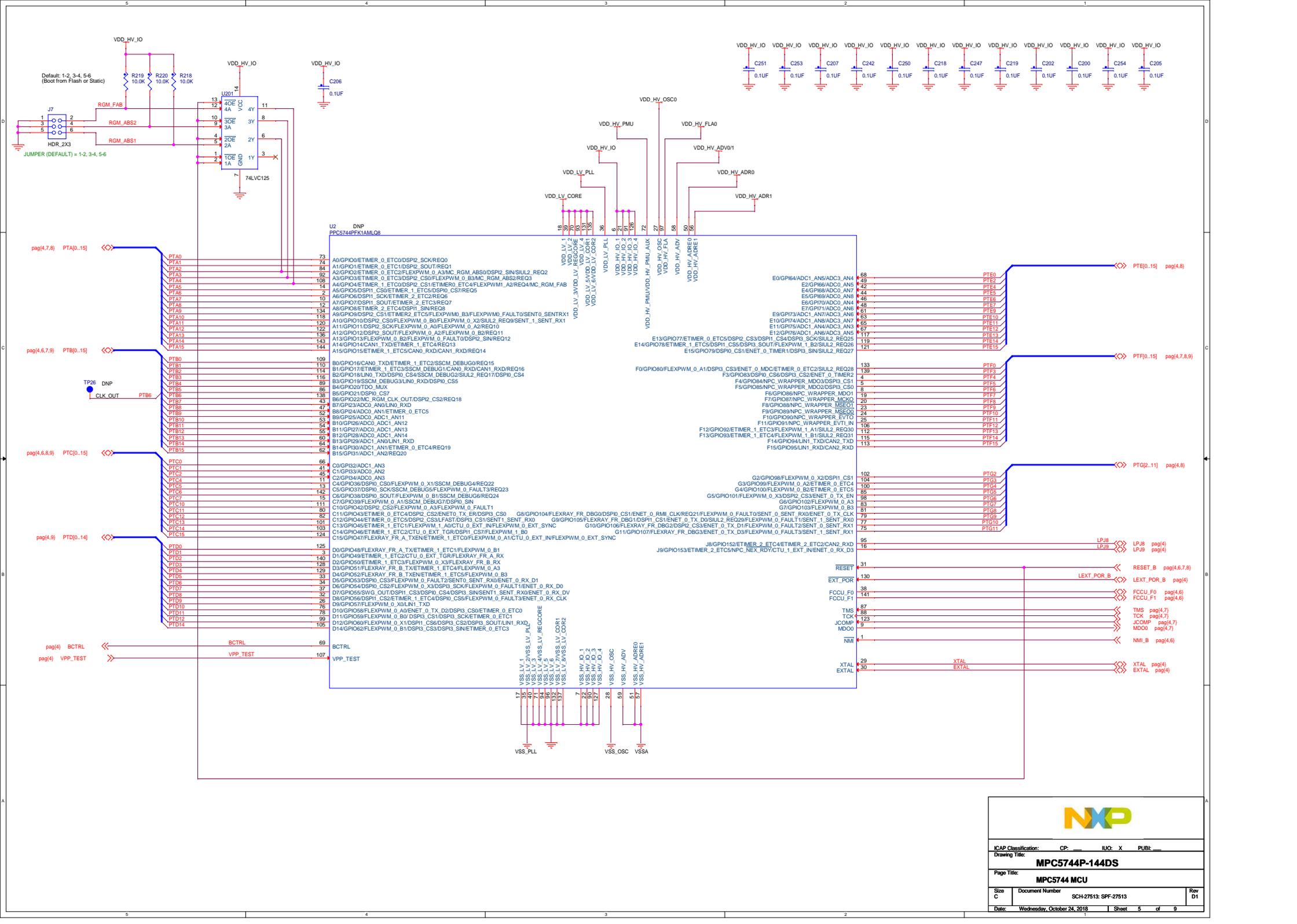
PTJ8, 9 pag(5,7,8)  
 EXT\_POR\_B pag(5,7)  
 LEXT\_POR\_B pag(5,7)  
 FCCU\_F0 pag(5,8)  
 FCCU\_F1 pag(5,8)  
 TMS pag(5,7)  
 TCK pag(5,7)  
 JCOMP pag(5,7)  
 MD00 pag(5,7)  
 NMI\_B pag(5,6)  
 XTAL pag(5)  
 XTAL pag(5)

ICAP Classification: CP IUC X PUBI			
Drawing Title: <b>MPC5744P144DS</b>			
Page Title: <b>MPC5744 MCU in SKT</b>			
Size C	Document Number	SCH-27513: SFP-27513	Rev D1
Date:	Wednesday, October 24, 2018	Sheet 4	of 9

**Providing External clock via SMA, J11**

J14 : No Shunt (Removing Jumper wire between Crystal & XTAL)  
 J15 : Shunt 1-2 (Adding jumper wire between SW & XTAL)  
 J16 : Shunt 1-2 (Terminating the MCU XTAL trace to GND via 49.9)  
 J17 : Shunt 1-2 (Terminating the MCU XTAL trace to GND)

To use the OSC is similar to using the SMA connector, but the jumper to the 49.9 ohm resistor is not used (J16-DNP)



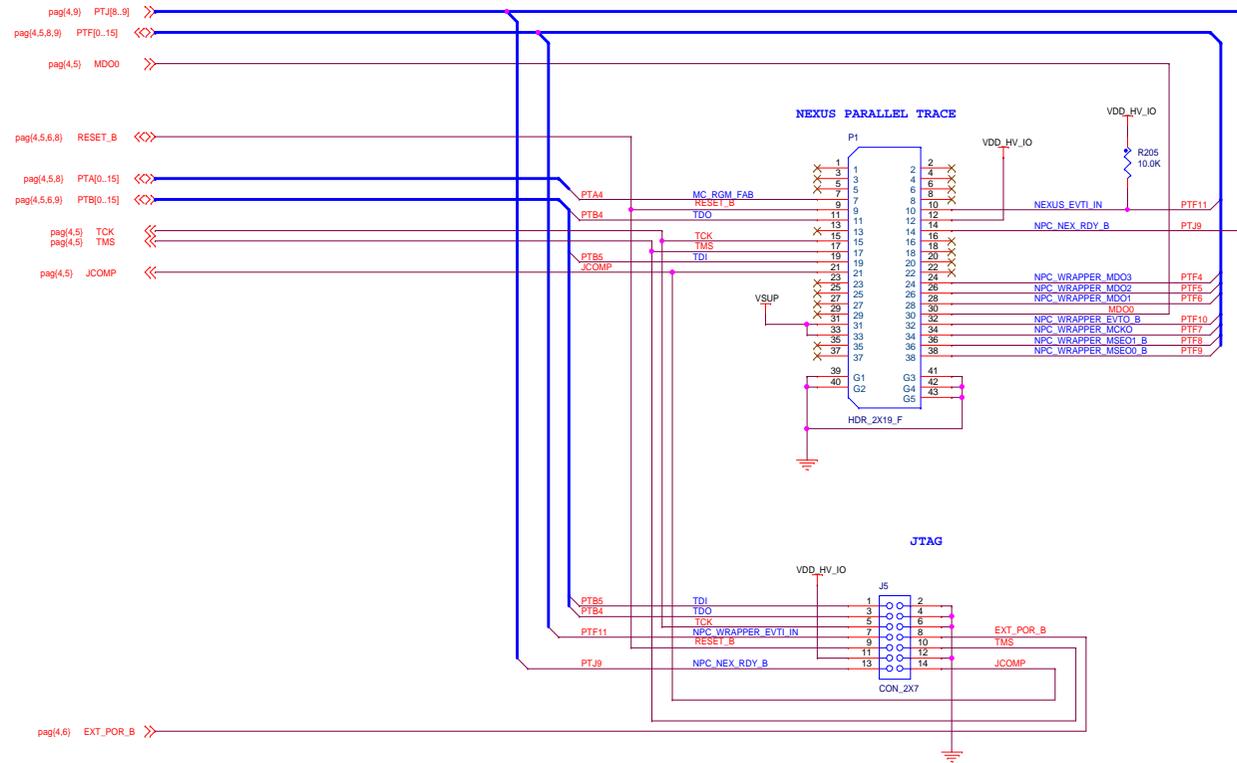
**NXP**

ICAP Classification: CP IUC X PUB: \_\_\_\_\_  
 Drawing Title: **MPC5744P-144DS**  
 Page Title: **MPC5744 MCU**

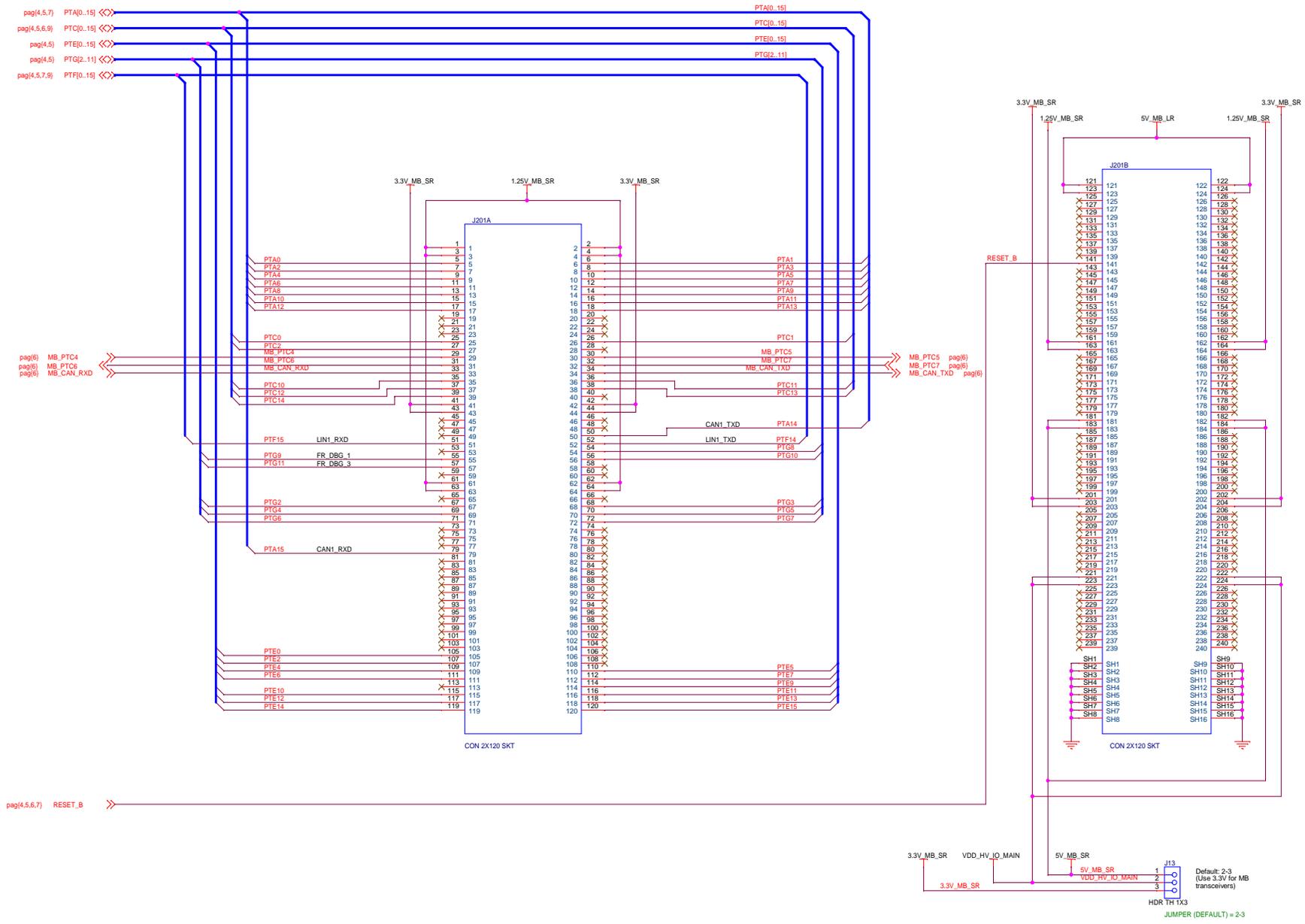
Size C	Document Number	SCH-27513; SPF-27513	Rev D1
Date:	Wednesday, October 24, 2018	Sheet	5 of 9



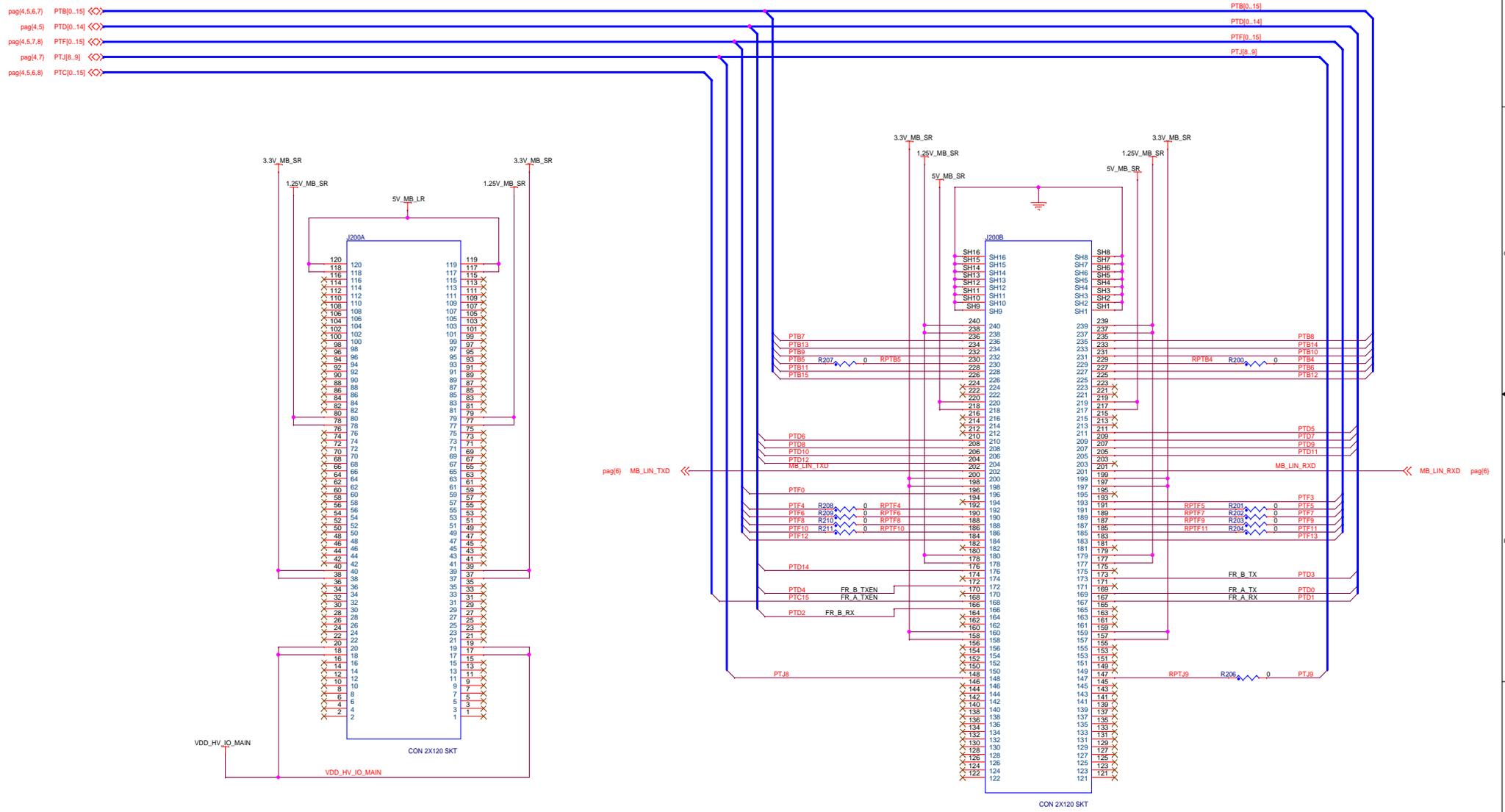
# JTAG & NEXUS PARALLEL TRACE



# Mother Board connections - 1



# Mother Board connections - 2





ICAP Classification: CP: _____ IUC: X PUB: _____			
Drawing Title: <b>MPC5744P-144DS</b>			
Page Title: <b>MB Connections 2</b>			
Size C	Document Number	SCH-27513: SPF-27513	Rev D1
Date:	Wednesday, October 24, 2018	Sheet 9 of 9	